



Docket No.: M4065.0222/P222-B
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Tongbi Jiang

Application No.: 10/667,391

Confirmation No.: 1655

Filed: September 23, 2003

Art Unit: 2829

For: METHOD OF MAKING A CENTER BOND
FLIP CHIP SEMICONDUCTOR CARRIER
(as amended)

Examiner: S. B. Geyer

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated November 15, 2005, please amend the above-identified U.S. patent application as follows:

Amendments to the Specification begin on page 2 of this paper.

Remarks begin on page 3 of this paper.